TOSHIBA CMOS Linear Integrated Circuit Silicon Monolithic

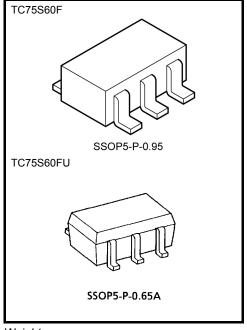
# TC75S60F, TC75S60FU

#### Single Operational Amplifier

TC75S60F, TC75S60FU are CMOS operational amplifier with low supply voltage, low supply current.

#### **Features**

- High slew rate: SR  $(V_{DD} = 3 \text{ V}) = 5.1 \text{ V/}\mu\text{s}$  (typ.)
- The power supply operation range is:  $V_{DD} = \pm 0.9$  to 3.5 V or 1.8 to 7 V
- Low supply current:  $IDD (VDD = 3 V) = 330 \mu A (typ.)$
- The internally phase compensated operational amplifier.
- Small package



Weight

SSOP5-P-0.95 : 0.014 g (typ.) SSOP5-P-0.65A : 0.006 g (typ.)

### Absolute Maximum Ratings (Ta = 25°C)

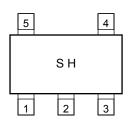
Characteristics	Symbol	Rating	Unit
Supply voltage	V <sub>DD</sub> , V <sub>SS</sub>	7	٧
Differential input voltage	DV <sub>IN</sub>	±7	٧
Input voltage	V <sub>IN</sub>	$V_{DD}$ to $V_{SS}$	٧
Power dissipation	$P_{D}$	200	mW
Operating temperature	T <sub>opr</sub>	-40 to 85	°C
Storage temperature	T <sub>stg</sub>	-55 to 125	°C

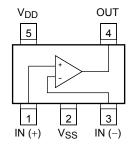
Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

## Marking (top view)

## Pin Connection (top view)





#### **Electrical Characteristics**

### DC Characteristics (V<sub>DD</sub> = 3.0 V, V<sub>SS</sub> = GND, Ta = 25°C)

Characteristics	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit
Input offset voltage	V <sub>IO</sub>	1	$R_S = 1 k\Omega$	_	2	7	mV
Input offset current	I <sub>IO</sub>	_	_	_	1	_	pА
Input bias current	lį	_	_	_	1	_	pА
Common mode input voltage	CMVIN	2	_	0.0	_	2.1	V
Voltage gain (open loop)	G <sub>V</sub>	_	_	60	70	_	dB
Maximum output voltage	V <sub>OH</sub>	3	R <sub>L</sub> = 100 kΩ	2.9	_	_	V
	V <sub>OL</sub>	4	R <sub>L</sub> = 100 kΩ	_	_	0.1	
Common mode rejection ratio	CMRR	2	V <sub>IN</sub> = 0.0 to 2.1 V	54	70	_	dB
Supply voltage rejection ratio	SVRR	1	V <sub>DD</sub> = 1.8 to 7.0 V	60	70	_	dB
Supply current	I <sub>DD</sub>	5	_	_	330	500	μА
Source current	I <sub>source</sub>	6	_	330	700	_	μА
Sink current	I <sub>sink</sub>	7	_	600	1250	_	μА

## DC Characteristics ( $V_{DD} = 1.8 \text{ V}, V_{SS} = GND, Ta = 25^{\circ}C$ )

Characteristics	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit
Input offset voltage	V <sub>IO</sub>	1	$R_S = 10 \text{ k}\Omega$	_	2	7	mV
Input offset current	I <sub>IO</sub>	_	_	_	1	_	pA
Input bias current	lį	_	_	_	1	_	pА
Common mode input voltage	CMV <sub>IN</sub>	2	_	0.3	_	0.9	V
Voltage gain (open loop)	G <sub>V</sub>	_	_	_	70	_	dB
maximum output voltage	V <sub>OH</sub>	3	$R_L = 100 \text{ k}\Omega$	1.7	_	_	V
	V <sub>OL</sub>	4	$R_L = 100 \text{ k}\Omega$	_	_	0.1	
Common mode rejection ratio	CMRR	2	V <sub>IN</sub> = 0.3 to 0.9 V	50	60	_	dB
Supply current	I <sub>DD</sub>	5	_	_	300	450	μА
Source current	I <sub>source</sub>	6	_	300	600	_	μА
Sink current	I <sub>sink</sub>	7	_	550	1150	_	μА

#### AC Characteristics (V<sub>DD</sub> = 3.0 V, V<sub>SS</sub> = GND, Ta = 25°C)

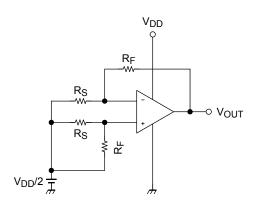
Characteristics	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit
Slew rate	SR	_	_	_	5.1	_	V/μs
Unity gain cross frequency	f <sub>T</sub>	_	_		3.7		MHz

#### AC Characteristics (V<sub>DD</sub> = 1.8 V, V<sub>SS</sub> = GND, Ta = 25°C)

Characteristics	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit
Slew rate	SR	_	_	_	4.0	_	V/μs
Unity gain cross frequency	f⊤	_	_	_	3.0	_	MHz

#### **Test Circuit**

### 1. SVRR, V<sub>IO</sub>



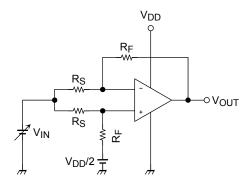
SVRR V<sub>DD</sub> = 1.8 V: V<sub>DD</sub> = V<sub>DD</sub>1, V<sub>OUT</sub> = V<sub>OUT</sub>1 V<sub>DD</sub> = 7.0 V: V<sub>DD</sub> = V<sub>DD</sub>2, V<sub>OUT</sub> = V<sub>OUT</sub>2

$$SVRR = 20 \log \left( \left| \frac{VOUT^{1} - VOUT^{2}}{V_{DD}^{1} - V_{DD}^{2}} \right| \times \frac{R_{S}}{R_{F} + R_{S}} \right)$$

• V<sub>IO</sub>

$$V_{IO} = \left(V_{OUT} - \frac{V_{DD}}{2}\right) \times \frac{R_S}{R_F + R_S}$$

#### 2. CMRR, CMV<sub>IN</sub>



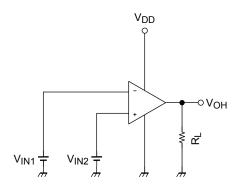
• CMRR

$$V_{IN} = 0.0 \text{ V: } V_{IN} = V_{IN}1, V_{OUT} = V_{OUT}1$$
  
 $V_{IN} = 2.1 \text{ V: } V_{IN} = V_{IN}2, V_{OUT} = V_{OUT}2$ 

$$CMRR = 20 \log \left( \left| \frac{V_{OUT}1 - V_{OUT}2}{V_{IN}1 - V_{IN}2} \right| \times \frac{R_S}{R_F + R_S} \right)$$

CMV<sub>IN</sub>

## 3. V<sub>OH</sub>

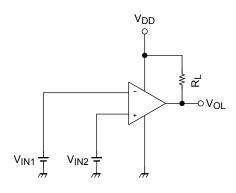


#### V<sub>OH</sub>

$$V_{IN1} = \frac{V_{DD}}{2} - 0.05 \text{ V}$$

$$V_{IN2} = \frac{V_{DD}}{2} + 0.05 \text{ V}$$

### 4. V<sub>OL</sub>



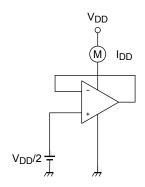
#### V<sub>OL</sub>

$$V_{IN1} = \frac{V_{DD}}{2} + 0.05 \text{ V}$$

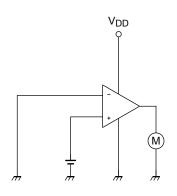
$$V_{IN2} = \frac{V_{DD}}{2} - 0.05 \text{ V}$$

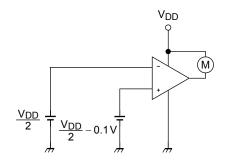
## 5. I<sub>DD</sub>

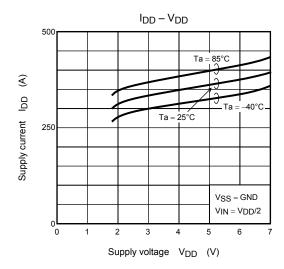
6. I<sub>source</sub>

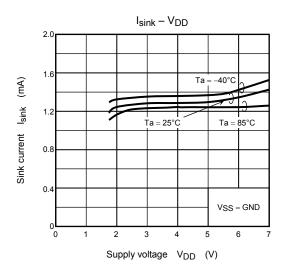


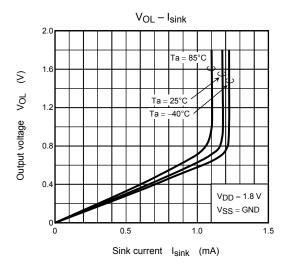
## 7. I<sub>sink</sub>

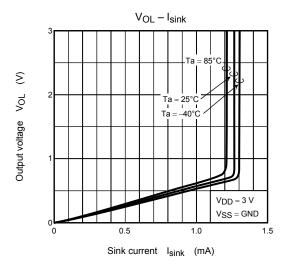


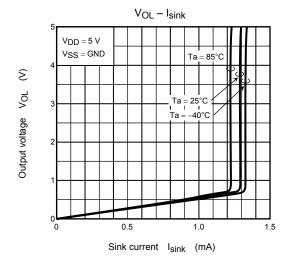


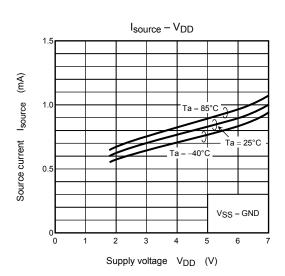




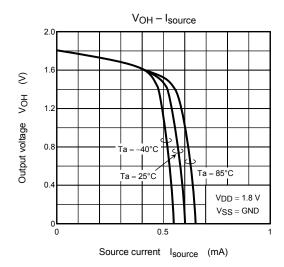


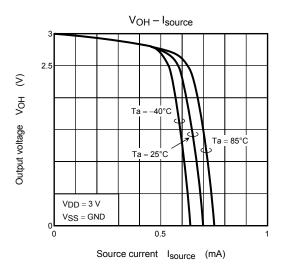


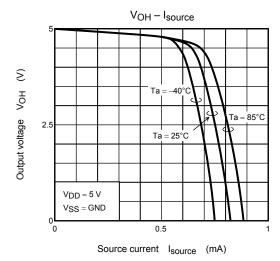


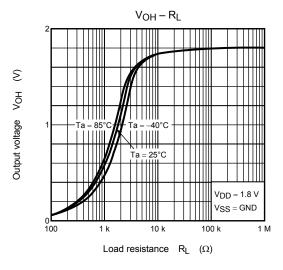


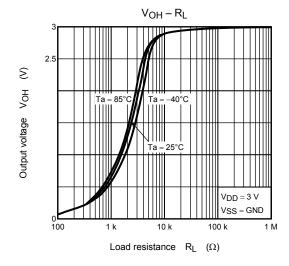
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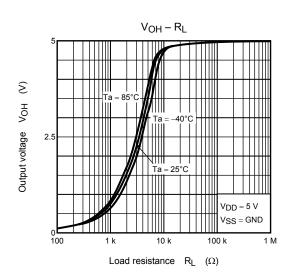


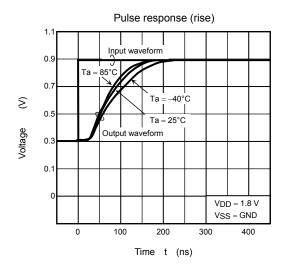


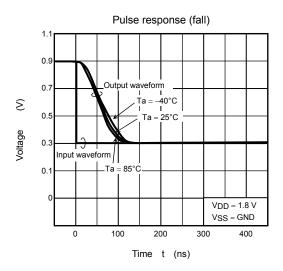


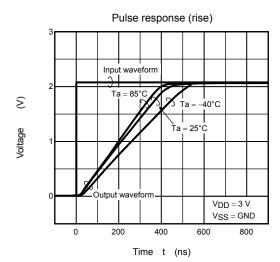


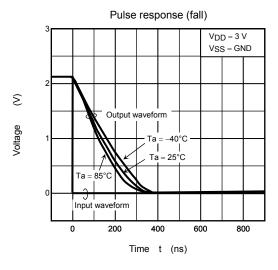


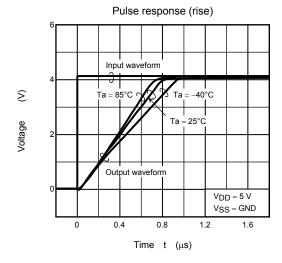


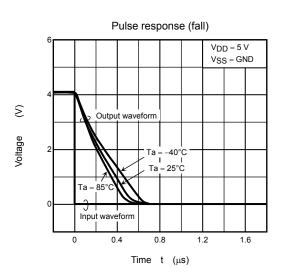


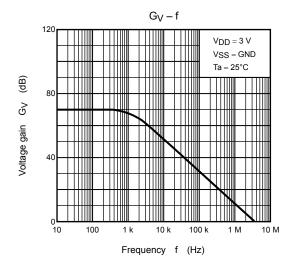


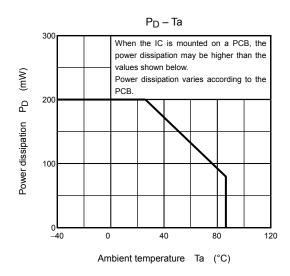






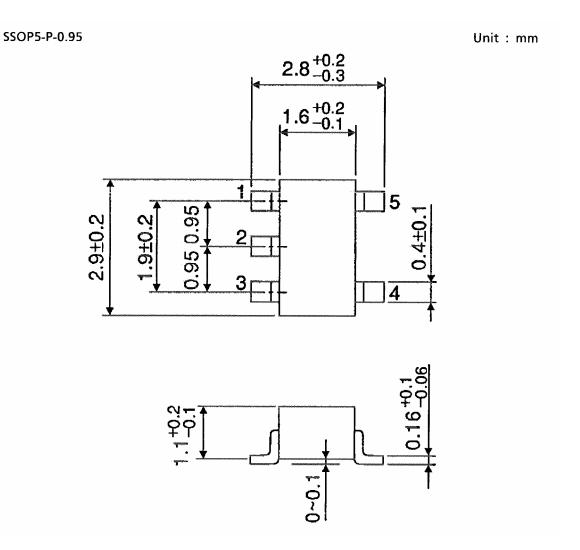






8 2014-03-01

## **Package Dimensions**

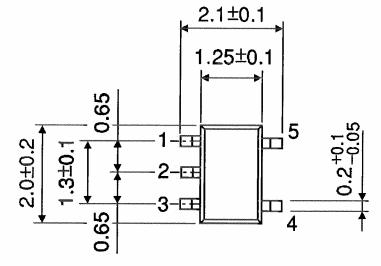


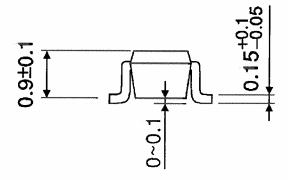
Weight: 0.014 g (typ.)

9 2014-03-01

## **Package Dimensions**

SSOP5-P-0.65A Unit: mm





Weight: 0.006 g (typ.)

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